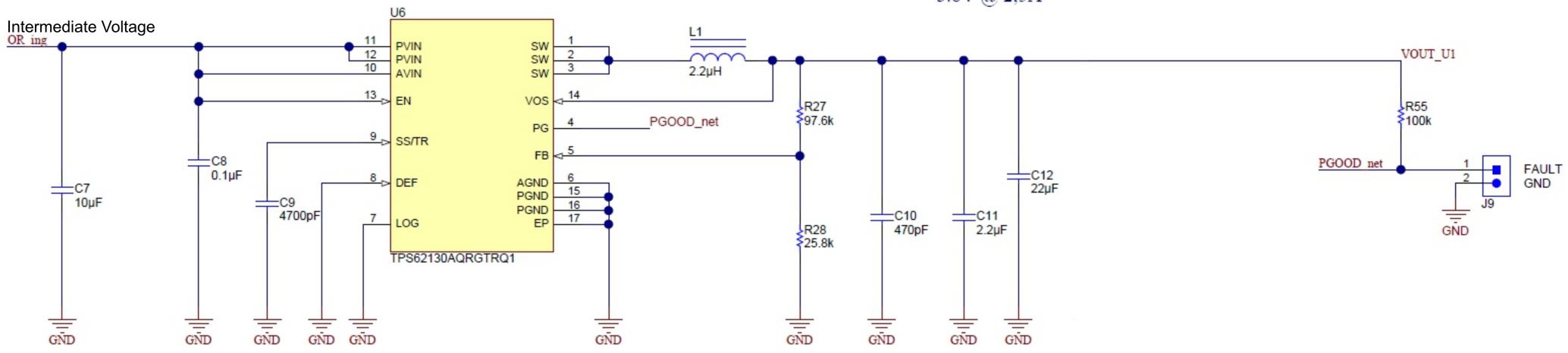
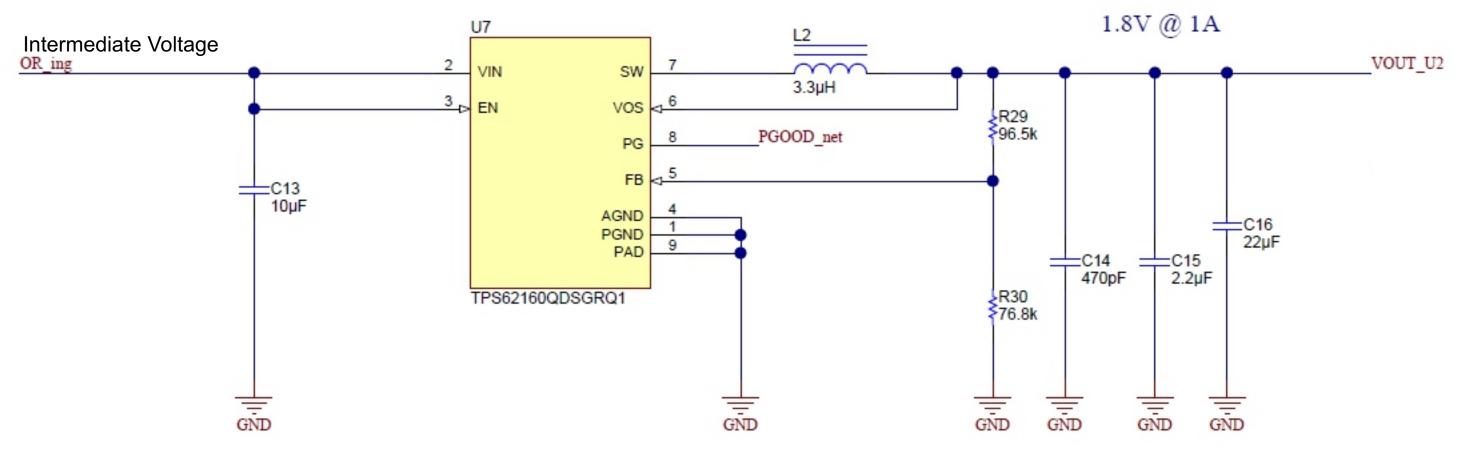


GSM module



MCU

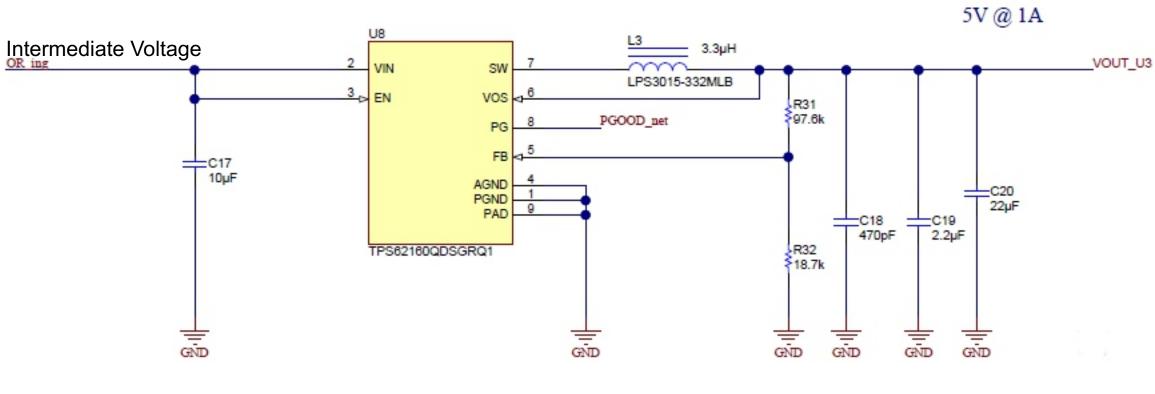


3.8V @ 2,5A

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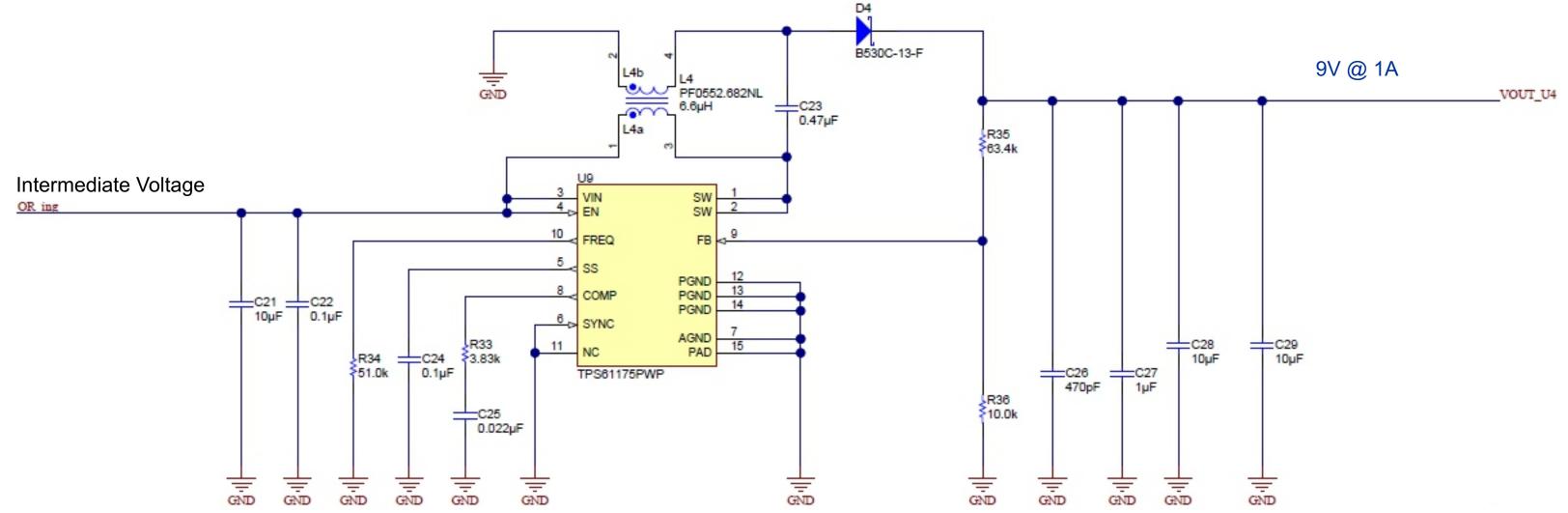
PMP9768 High Voltage e-call Power Supply - 2

GPS module



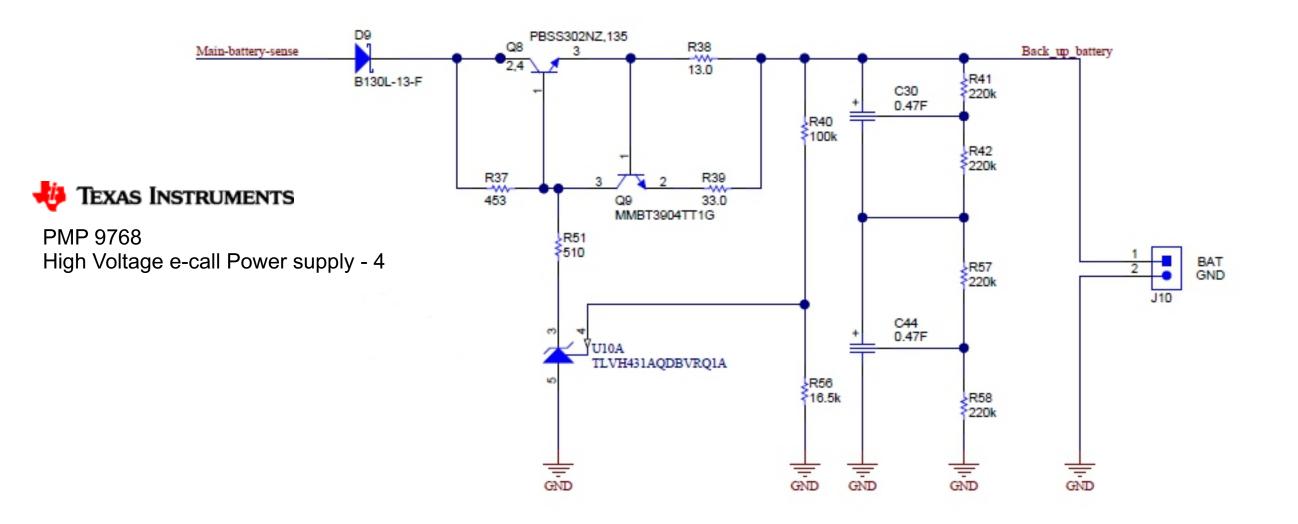
PMP9768

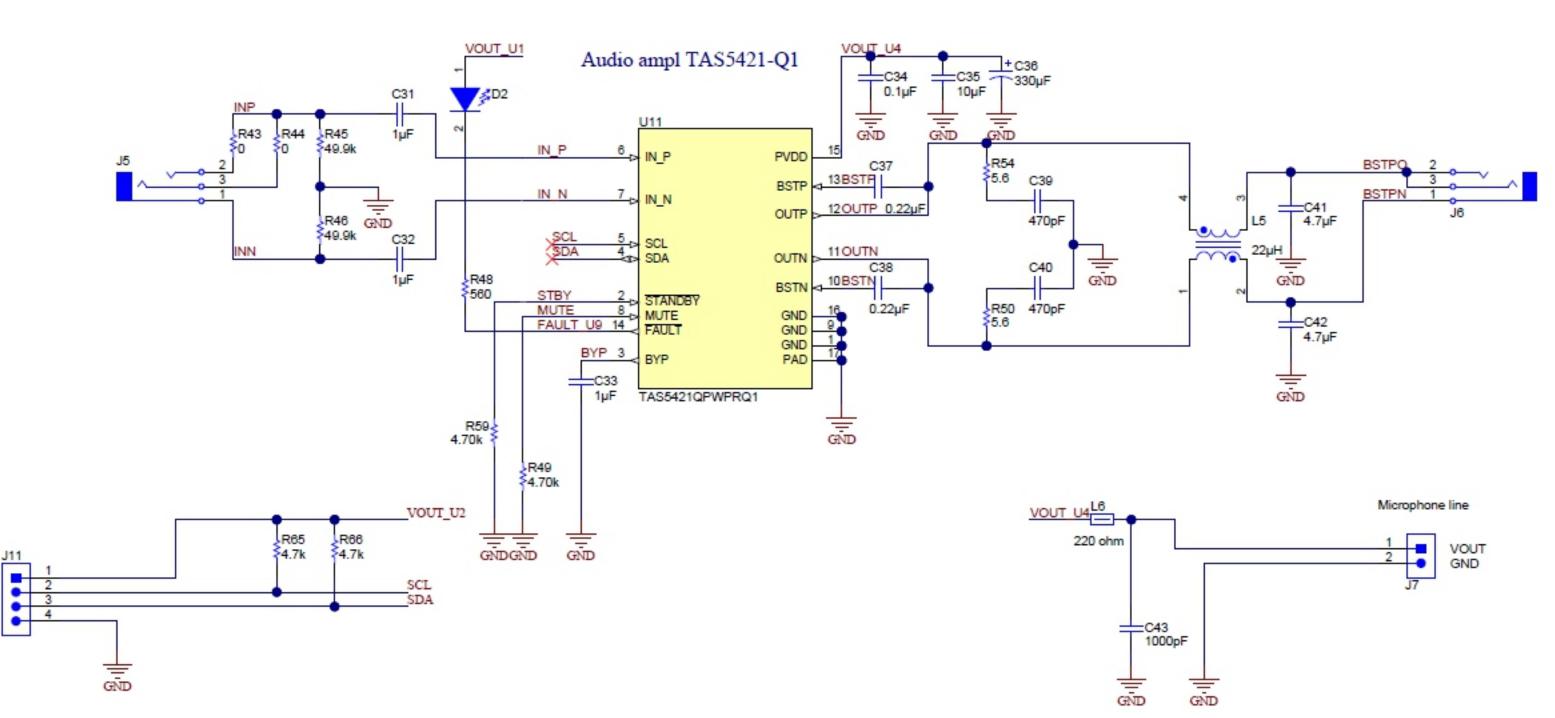
Audio ampl TAS5421-Q1



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High Voltage e-call Power Supply - 3





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